

### **Features**

- Surface mount packaging for automated assembly
- 0603 footprint size and low profile for spaceconstrained mobile applications
- Ultra-low resistance, quick response
- RoHS compliant\* and halogen free\*\*

#### **Additional Information**

Click these links for more information:











PRODUCT TECHNICAL INVENTORY SAMPLES CONTACT LIBRARY

# MF-FSML/X Series - Low Ohmic PTC Resettable Fuses

#### **Electrical Characteristics**

Model V r	V max.	I max.	I <sub>hold</sub>	I <sub>trip</sub>	Resistance Max. Time To Trip		Tripped Power Dissipation	Certifications			
			at 23 °C		at 23 °C Ohms		at 23 °C		Watts at 23 °C	cUL	ΤÜV
	Volts	Amps	Am	ıps	R <sub>min</sub>	R <sub>1</sub> max	Amps	Seconds	Тур.	E174545	R50391579
MF-FSML035/8	8	50	0.35	0.75	0.080	1.000	8.0	0.1	0.5	<b>√</b>	/
MF-FSML050/8	8	50	0.50	1.00	0.060	0.500	8.0	0.6	0.5	✓	1
MF-FSML075/8	8	50	0.75	1.50	0.050	0.250	8.0	1.0	0.5	✓	/
MF-FSML100/8	8	50	1.00	2.00	0.040	0.220	8.0	2.0	0.5	✓	1
MF-FSML125/8	8	50	1.25	2.50	0.020	0.180	8.0	3.0	0.5	✓	/
MF-FSML150/8	8	50	1.50	3.00	0.010	0.120	8.0	4.0	0.6	✓	1
MF-FSML175/8	8	50	1.75	3.50	0.008	0.070	8.0	5.0	0.6	1	1
MF-FSML200/6	6	50	2.00	4.00	0.006	0.065	8.0	5.0	0.7	✓	1
MF-FSML250/6	6	50	2.50	5.00	0.0035	0.060	8.0	5.0	0.7	✓	1
MF-FSML260/6	6	50	2.60	5.20	0.0035	0.055	8.0	5.0	0.7	✓	1
MF-FSML300/6	6	50	3.00	6.00	0.003	0.050	8.0	5.0	0.7	✓	1

### **Environmental Characteristics**

Item		Condition	Criteria		
Operating Temperature		-40 °C to +85 °C			
Storage Condition	Before Opening	+40 °C max. / 70 % RH max.			
Storage Condition	After Opening	+40 °C max. / 10 % RH max.			
Floor Condition After Opening		Consumption within 4 weeks at floor condition +30 °C max. / 60 % RH max.			
Passive Aging		+85 °C, 1000 hours	±10 % typical resistance change		
Humidity Aging		+85 °C, 85 % R.H. 100 hours	±15 % typical resistance change		
Thermal Shock		-40 °C to +85 °C, 20 times	±30 % typical resistance change		
Vibration		MIL-STD-883C, Method 2007.1 Condition A	No change (R <sub>min</sub> < R < R <sub>1max</sub> )		
Moisture Sensitivity Lev	vel (MSL)	See Note			
ESD Classification		Class 6 (per AEC-Q200-2, HBM)			

Bourns considers a product to be "halogen free" if (a) the Bromine (Br) content is 900 ppm or less; (b) the Chlorine (CI) content is 900 ppm or less; and (c) the total Bromine (Br) and Chlorine (Cl) content is 1500 ppm or less. Specifications are subject to change without notice. Users should verify actual device performance in their specific applications. The products described herein and this document are subject to specific legal disclaimers as set forth on the last page of this document, and at www.bourns.com/docs/legal/disclaimer.pdf.



<sup>\*</sup> RoHS Directive 2015/863, Mar 31, 2015 and Annex.

### **Applications**

- Thermal protection for wearables, Li-ion & polymer battery packs
- PC motherboards Plug & Play protection
- Mobile phone, PDA / digital camera battery & charging protection
- HDMI 1.4 source protection
- Game console port protection

# MF-FSML/X Series - Low Ohmic PTC Resettable Fuses **POURNS**

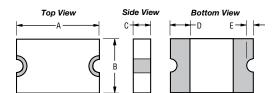
### **Test Procedures and Requirements**

Item	Test Condition	Accept/Reject Criteria	
Visual/Mechanical	Verify dimensions and materials	Per MF physical description	
Resistance	In still air @ 23 °C	$R_{min} \le R \le R_{max}$	
Time to Trip	At specified current, V <sub>max</sub> , 23 °C, still air	T ≤ max. time to trip (seconds)	
Hold Current	30 min. at I <sub>hold</sub> , still air	No trip	
Trip Cycle Life	V <sub>max</sub> , I <sub>max</sub> , 100 cycles	No arcing or burning	
Trip Endurance	V <sub>max</sub> , 48 hours	No arcing or burning	
Solderability	245 °C ±5 °C, 5 seconds	95 % min. coverage	

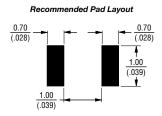
### **Product Dimensions**

Model	Α		В		С		D	E	
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.	Max.
MF-FSML035/8									
MF-FSML050/8									
MF-FSML075/8	1.45 (0.057)	1.85 (0.073)	0.65 (0.026)	1.05 (0.041)	0.40 (0.016)	0.70 (0.028)			
MF-FSML100/8	(0.007)	(0.070)	(0.020)	(0.041)	(0.010)	(0.020)			
MF-FSML125/8									
MF-FSML150/8							0.20 (0.008)	0.05 (0.002)	0.35 (0.014)
MF-FSML175/8							(0.000)	(0.002)	(0.014)
MF-FSML200/6	1.45	1.85	0.65	1.05	0.60	1.00			
MF-FSML250/6	(0.057)	(0.073)	(0.026)	(0.041)	(0.024)	(0.039)			
MF-FSML260/6									
MF-FSML300/6									

DIMENSIONS:  $\frac{MM}{(INCHES)}$ 



**Terminal material:** ENIG-plated terminals



# MF-FSML/X Series - Low Ohmic PTC Resettable Fuses

### **Packaging Quantity**

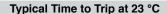
MF-FSML035/8  $\sim$  MF-FSML125/8 = 6000 pcs. per reel MF-FSML150/8 ~ MF-FSML300/6 = 4000 pcs. per reel

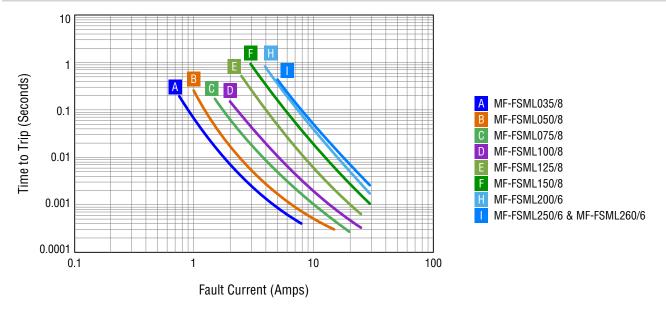
### Thermal Derating Table - Ihold (Amps)

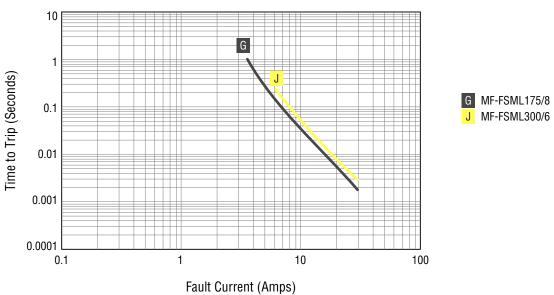
Model	Ambient Operating Temperature									
	-40 °C	-20 °C	0 °C	23 °C	40 °C	50 °C	60 °C	70 °C	85 °C	
MF-FSML035/8	0.46	0.40	0.38	0.35	0.29	0.26	0.24	0.20	0.14	
MF-FSML050/8	0.66	0.57	0.54	0.50	0.41	0.37	0.34	0.28	0.20	
MF-FSML075/8	1.00	0.86	0.81	0.75	0.62	0.56	0.51	0.43	0.30	
MF-FSML100/8	1.32	1.15	1.08	1.00	0.82	0.74	0.68	0.57	0.40	
MF-FSML125/8	1.65	1.43	1.35	1.25	1.04	0.92	0.85	0.71	0.51	
MF-FSML150/8	2.00	1.73	1.62	1.50	1.21	1.09	1.02	0.84	0.62	
MF-FSML175/8	2.30	2.00	1.89	1.75	1.42	1.28	1.20	0.98	0.71	
MF-FSML200/6	2.63	2.27	2.15	2.00	1.63	1.45	1.37	1.12	0.82	
MF-FSML250/6	3.27	2.85	2.70	2.50	2.02	1.82	1.70	1.40	1.02	
MF-FSML260/6	3.41	2.96	2.80	2.60	2.11	1.90	1.77	1.45	1.05	
MF-FSML300/6	3.92	3.42	3.25	3.00	2.42	2.20	2.06	1.68	1.20	

# MF-FSML/X Series - Low Ohmic PTC Resettable Fuses

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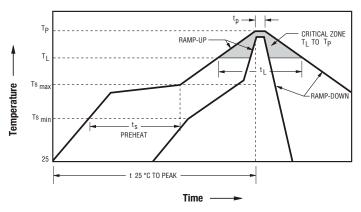


The Time to Trip curves represent typical performance of a device in a simulated application environment.

Actual performance in specific customer applications may differ from these values due to the influence of other variables

# MF-FSML/X Series - Low Ohmic PTC Resettable Fuses **BOURNS**

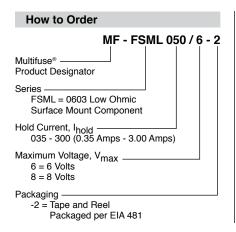
### **Solder Reflow Recommendations**



#### Notes:

- MF-FSML/X models are intended for reflow soldering (including, but not limited to heating plate, hot air, IR, nitrogen, and vapor phase).
- Wave soldering is permissible only if the device is on the top of the PCB, opposite the heat source.
- · Hand soldering is not recommended for these devices.
- All temperatures refer to the topside of the device, measured on the device body surface.
- If reflow temperatures exceed the recommended profile, devices may not meet the published specifications.
- · Compatible with Pb and Pb-free solder reflow profiles.
- · Excess solder may cause a short circuit.
- Please refer to the Multifuse® Polymer PTC Resettable Fuse Soldering Recommendations document for more details.

Profile Feature	Pb-Free Assembly					
Average Ramp-Up Rate (Ts <sub>max</sub> to T <sub>p</sub> )	3 °C / second max.					
PREHEAT:						
Temperature Min. (Ts <sub>min</sub> )	150 °C					
Temperature Max. (Ts <sub>max</sub> )	200 °C					
Time (Ts <sub>min</sub> to Ts <sub>max</sub> ) (ts)	60~180 seconds					
TIME MAINTAINED ABOVE:						
Temperature (T <sub>L</sub> )	217 °C					
Time (t <sub>L</sub> )	60~150 seconds					
Peak Temperature (T <sub>p</sub> )	260 °C					
Time within 5 °C of Actual Peak Temperature (t <sub>p</sub> )	20~40 seconds					
Ramp-Down Rate	6 °C / second max.					
Time 25 °C to Peak Temperature	8 minutes max.					



#### Typical Part Marking

No marking.

Specifications are subject to change without notice.

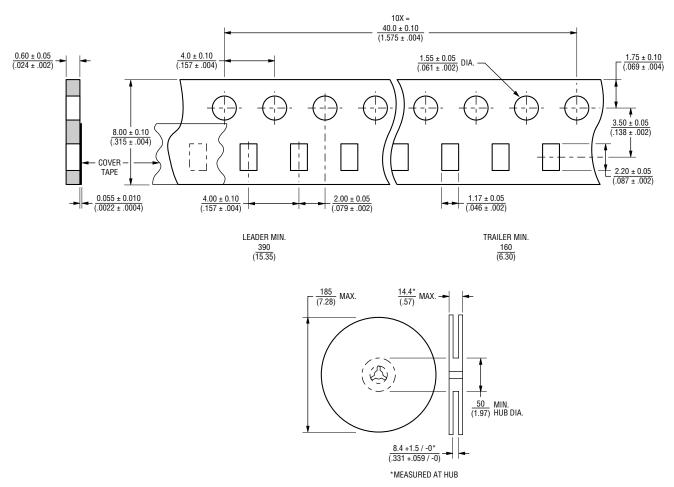
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# MF-FSML/X Series - Low Ohmic PTC Resettable Fuses **BOURNS**

### **Packaging Specifications**

MF-FSML/X Series per EIA 481



DIMENSIONS:  $\frac{MM}{(INCHES)}$ 

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MF-FSML/X SERIES, REV. B, 10/21

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## **Bourns® Multifuse® PPTC Resettable Fuses**

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### **Application Notice**

- Users are responsible for independent and adequate evaluation of Bourns® Multifuse® Polymer PTC devices in the user's
  application, including the PPTC device characteristics stated in the applicable data sheet.
- Polymer PTC devices must not be allowed to operate beyond their stated maximum ratings. Operation in excess of such
  maximum ratings could result in damage to the PTC device and possibly lead to electrical arcing and/or fire. Circuits with
  inductance may generate a voltage above the rated voltage of the polymer PTC device and should be thoroughly evaluated
  within the user's application during the PTC selection and qualification process.
- Polymer PTC devices are intended to protect against adverse effects of temporary overcurrent or overtemperature
  conditions up to rated limits and are not intended to serve as protective devices where overcurrent or overvoltage conditions
  are expected to be repetitive or prolonged.
- In normal operation, polymer PTC devices experience thermal expansion under fault conditions. Thus, a polymer PTC
  device must be protected against mechanical stress, and must be given adequate clearance within the user's application to
  accommodate such thermal expansion. Rigid potting materials or fixed housings or coverings that do not provide adequate
  clearance should be thoroughly examined and tested by the user, as they may result in the malfunction of polymer PTC
  devices if the thermal expansion is inhibited.
- Exposure to lubricants, silicon-based oils, solvents, gels, electrolytes, acids, and other related or similar materials may adversely affect the performance of polymer PTC devices.
- Aggressive solvents may adversely affect the performance of polymer PTC devices. Conformal coating, encapsulating, potting, molding, and sealing materials may contain aggressive solvents including but not limited to xylene and toluene, which are known to cause adverse effects on the performance of polymer PTCs. Such aggressive solvents must be thoroughly cured or baked to ensure their complete removal from polymer PTCs to minimize the possible adverse effect on the device.
- Recommended storage conditions should be followed at all times. Such conditions can be found on the applicable data sheet and on the Multifuse® Polymer PTC Moisture/Reflow Sensitivity Classification (MSL) note: <a href="https://www.bourns.com/docs/RoHS-MSL/msl">https://www.bourns.com/docs/RoHS-MSL/msl</a> mf.pdf

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